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Sup*IR*Buck™

USER GUIDE FOR IR3843W EVALUATION BOARD

DESCRIPTION

The IR3843W is a synchronous buck converter, providing a compact, high performance and flexible solution in a small 5mmx6mm Power QFN package.

Key features offered by the IR3843W include programmable soft-start ramp, precision 0.7V reference voltage, Power Good, thermal protection, programmable switching frequency, Sequence input, Enable input, input under-voltage lockout for proper start-up, and pre-bias start-up. An output over-current protection function is implemented by sensing the voltage developed across the on-resistance of the synchronous rectifier MOSFET for optimum cost and performance.

This user guide contains the schematic and bill of materials for the IR3843W evaluation board. The guide describes operation and use of the evaluation board itself. Detailed application information for IR3843W is available in the IR3843W data sheet.

BOARD FEATURES

- V_{in} = +12V (13.2V Max)
- V_{cc}=+5V (5.5V Max)
- V_{out} = +1.8V @ 0- 2A
- F_s=600kHz
- L= 3.3uH
- C_{in}= 1x10uF (ceramic 1206) + 330uF (electrolytic)
- C_{out}= 2x22uF (ceramic 0805)

CONNECTIONS and OPERATING INSTRUCTIONS

A well regulated +12V input supply should be connected to VIN+ and VIN-. A maximum 2A load should be connected to VOUT+ and VOUT-. The connection diagram is shown in Fig. 1 and inputs and outputs of the board are listed in Table I.

IR3843W has two input supplies, one for biasing (Vcc) and the other as input voltage (Vin). Separate supplies should be applied to these inputs. Vcc input should be a well regulated 4.5V-5.5V supply and it would be connected to Vcc+ and Vcc-.

If single 12V application is required connect R7 (zero Ohm resistor) which enables the on board bias regulator (see schematic). In this case there is no need of external Vcc supply.

The output can track a sequencing input at the start-up. *For sequencing application, R16 should be* <u>removed and the external sequencing source should be applied between Seq. and Agnd.</u> The value of R14 and R28 can be selected to provide the desired ratio between the output voltage and the tracking input. *For* <u>proper operation of IR3843W, the voltage at Seq. pin should not exceed Vcc.</u>

| Connection | Signal Name | |
|------------|----------------------------|--|
| VIN+ | V _{in} (+12V) | |
| VIN- | Ground of V _{in} | |
| Vcc+ | Vcc input | |
| Vcc- | Ground for Vcc input | |
| VOUT- | Ground of V _{out} | |
| VOUT+ | V _{out} (+1.8V) | |
| Enable | Enable | |
| Seq. | Sequence Input | |
| P_Good | Power Good Signal | |

Table I. Connections

LAYOUT

The PCB is a 4-layer board. All of layers are 2 Oz. copper. The IR3843W SupIRBuck and all of the passive components are mounted on the top side of the board.

Power supply decoupling capacitors, the Bootstrap capacitor and feedback components are located close to IR3843W. The feedback resistors are connected to the output voltage at the point of regulation and are located close to the SupIRBuck. To improve efficiency, the circuit board is designed to minimize the length of the on-board power ground current path.



Connection Diagram

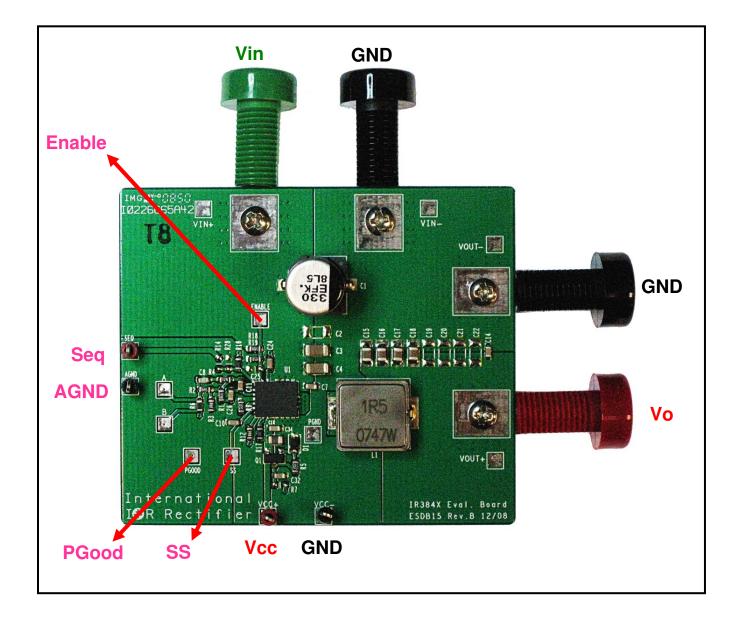


Fig. 1: Connection diagram of IR384xW evaluation boards

International

IRDC3843W

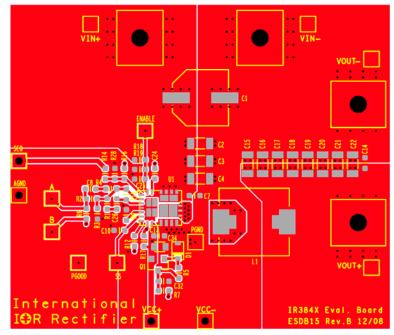


Fig. 2: Board layout, top overlay

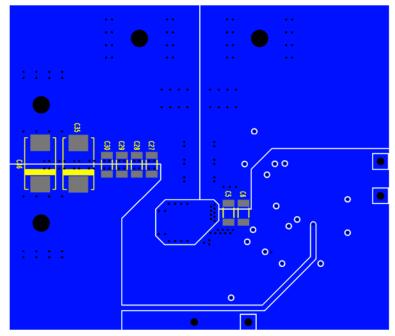


Fig. 3: Board layout, bottom overlay (rear view)

International

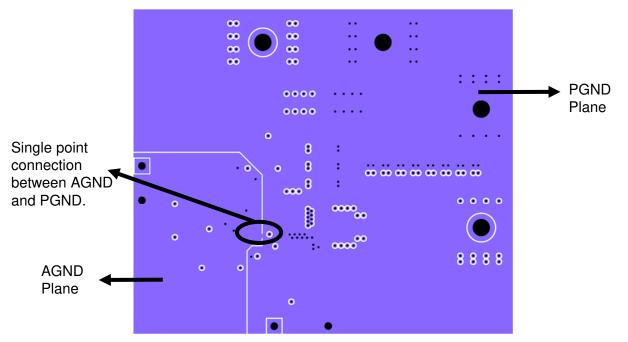


Fig. 4: Board layout, mid-layer I.

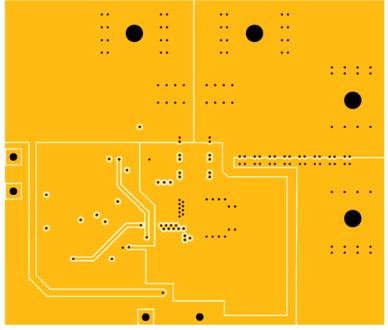
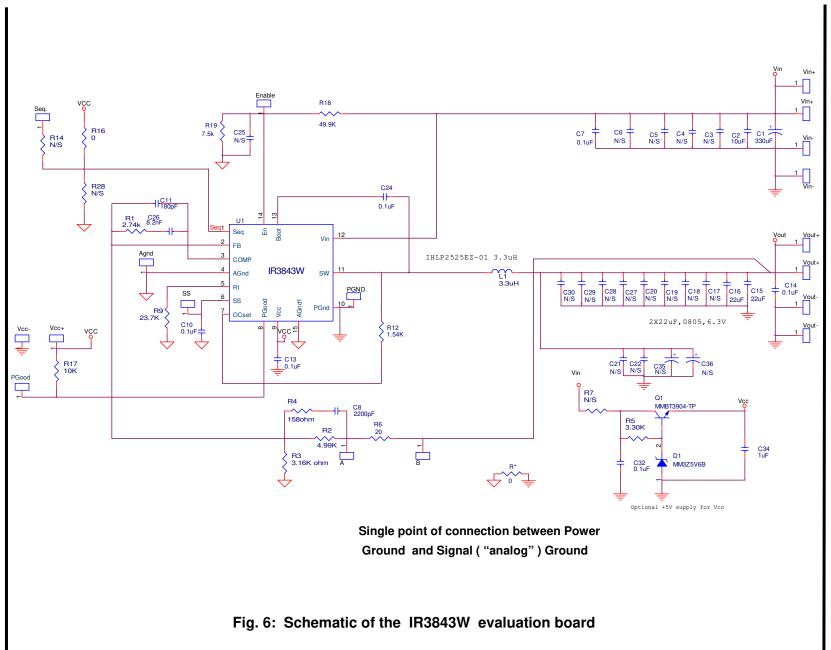


Fig. 5: Board layout, mid-layer II.



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IRDC3843W

International

CRRectifier

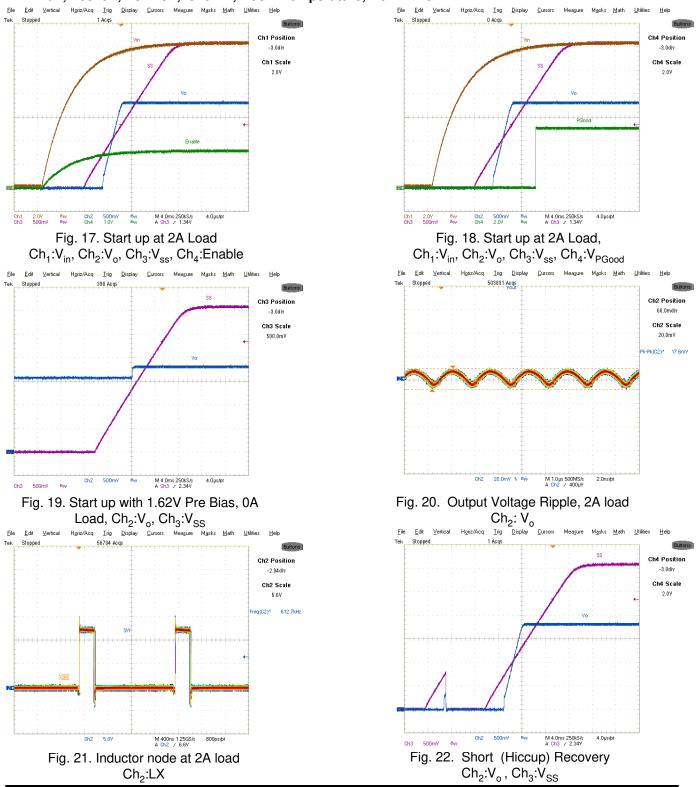
Bill of Materials

| Item | Quantity | Part Reference | Value | Description | Manufacturer | Part Number |
|------|----------|------------------------|--------------|----------------------------------|-------------------------|---------------------|
| 1 | 1 | C2 | 10uF | 1206,16V, X7R, 20% | Panasonic - ECG | ECJ-3YX1C106K |
| 2 | 1 | C1 | 330uF | SMD Elecrolytic, Fsize, 25V, 20% | Panasonic | EEV-FK1E331P |
| 3 | 6 | C7 C14 C24 C10 C13 C32 | 0.1uF | 0603, 25V, X7R, 10% | Panasonic | ECJ-1VB1E104K |
| 4 | 1 | C8 | 2200pF | 2200pF,0603,50V,X7R | Panasonic | ECJ-1VB1H222K |
| 5 | 1 | C11 | 180pF | 50V, 0603, NP0, 5% | Panasonic | ECJ-1VC1H181J |
| 6 | 2 | C15 C16 | 22uF | 0805, 6.3V, X5R, 20% | Panasonic | ECJ-2FB0J226M |
| 7 | 1 | C26 | 8200pF | 0603, 50V, X7R, 10% | Panasonic | ECJ-1VB1H822K |
| 8 | 1 | L1 | 3.3uH | 6.9x6.5x5mm, 8A,20% | Vishay/Dale | IHLP2525EZ-01 3.3uH |
| 9 | 1 | R1 | 2.74k | 0603,1/10W,1% | Rohm | MCR03EZPFX2741 |
| 10 | 1 | R2 | 4.99k | 0603,1/10W,1% | Rohm | MCR03EZPFX4991 |
| 11 | 1 | R3 | 3.16k | 0603,1/10W,1% | Rohm | MCR03EZPFX3161 |
| 12 | 1 | R4 | 158 | 0603,1/10W,1% | Panasonic | ERJ-3EKF1580V |
| 13 | 1 | R6 | 20 | 0603,1/10 W,1% | Vishay/Dale | CRCW060320R0FKEA |
| 14 | 1 | R9 | 23.7K | 0603,1/10W,1% | Rohm | MCR03EZPFX2372 |
| 15 | 1 | R16 | 0 | 0603,1/10 W,5% | Vishay/Dale | CRCW06030000Z0EA |
| 16 | 1 | R12 | 1.54K | 0603,1/10 W,1% | Rohm | MCR03EZPFX1541 |
| 17 | 1 | R17 | 10K | 0603,1/10 W,1% | Rohm | MCR03EZPFX1002 |
| 18 | 1 | R18 | 49.9k | 0603,1/10 W,1% | Rohm | MCR03EZPFX4992 |
| 19 | 1 | R19 | 7.5k | 0603,1/10W,1% | Rohm | MCR03EZPFX7501 |
| 20 | 1 | R5 | 3.3k | 0603,1/10W,1% | Rohm | MCR03EZPFX3301 |
| 21 | 1 | C34 | 1uF | 1uF, 10V, X5R,0805 | Panasonic | ECJ-2FB1C105K |
| 22 | 1 | D1 | MM3Z5V6B | Zener,5.6V | Fairchild | MM3Z5V6B |
| 23 | 1 | Q1 | MMBT3904/SOT | NPN, 200mA, 40V, SOT23 | Fairchild | MMBT3904/SOT |
| 24 | 1 | U1 | IR3843W | 2A SupIRBuck. PQFN 5x6mm | International Rectifier | IR3843WMPbF |

IRDC3843W

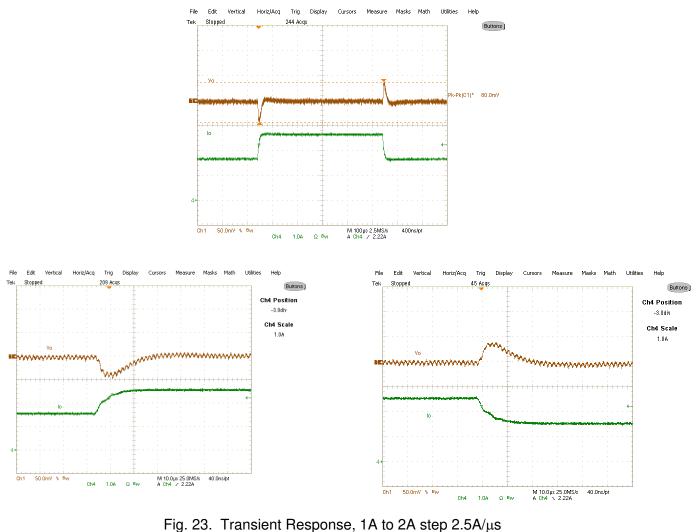
TYPICAL OPERATING WAVEFORMS

Vin=12.0V, Vcc=5V, Vo=1.8V, Io=0-2A, Room Temperature, No Air Flow





TYPICAL OPERATING WAVEFORMS Vin=12V, Vcc=5V, Vo=1.8V, Io=0-2A, Room Temperature, No Air Flow



 $Ch_1: V_o, Ch_4: I_o$

TYPICAL OPERATING WAVEFORMS Vin=12V, Vcc=5V, Vo=1.8V, Io=2A, Room Temperature, No Air Flow

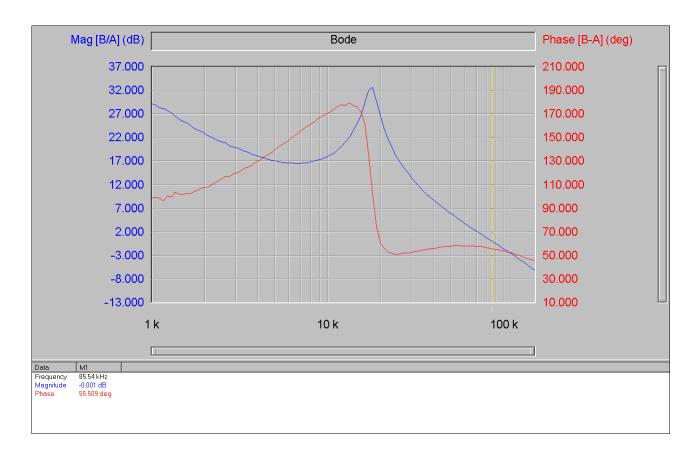
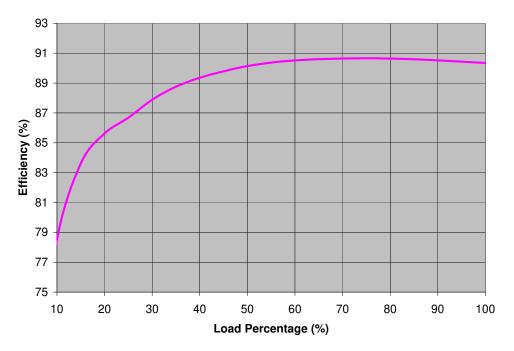
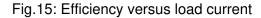


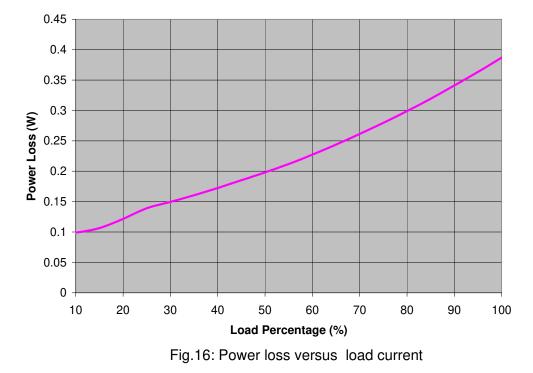
Fig. 24. Bode Plot at 2A load shows a bandwidth of 85.54kHz and phase margin of 55.509 degrees

TYPICAL OPERATING WAVEFORMS

Vin=12V, Vo=1.8V, Io=0- 2A, Room Temperature, No Air Flow







International

THERMAL IMAGES

Vin=12V, Vo=1.8V, Io=2A, Room Temperature, No Air Flow

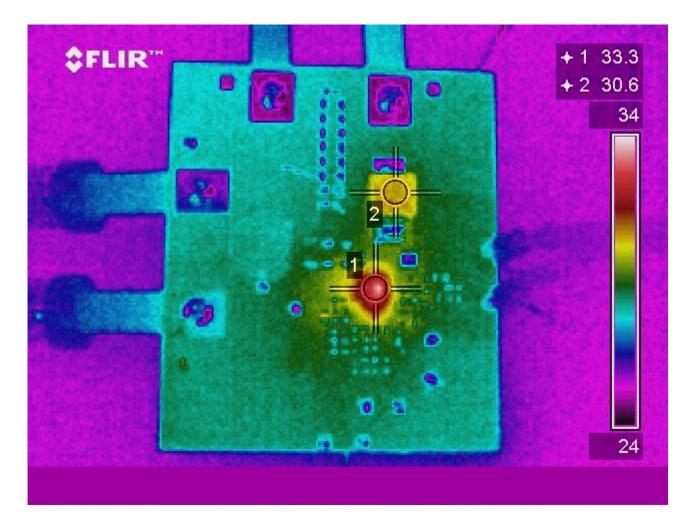
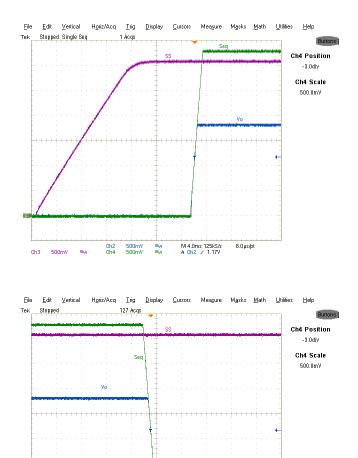


Fig. 17: Thermal Image at 2A load Test points 1 and 2 are IR3843W and inductor, respectively. Simultaneous Tracking at Power Up and Power Down Vin=12V, Vo=1.8V, Io=2A, Room Temperature, No Air Flow

- In order to run the IR3843W in the simultaneous tracking mode, the following steps should be taken:
- Remove R16 from the board.
- Set the value of R14 and R28 as R2 (4.99K) and R3 (3.16K), respectively.
- Connect the controlling input across SEQ and AGND test points on the board. This voltage should be at least 1.15 time greater than Vo. For the following test results a 0-3.3V source is applied to SEQ input.
- The controlling input should be applied after the SS pin is clamped to 3.0V.



M 4.0ms 125kS/s A Ch2 \ 1.17Y

Ch2 500mV Bw Ch4 500mV Bw

Ch3 500mV Bw

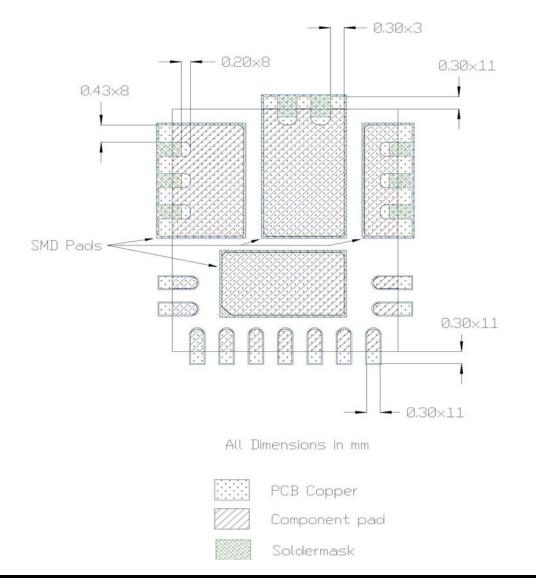
8.0us/bt

PCB Metal and Components Placement

The lead lands (the 11 IC pins) width should be equal to the nominal part lead width. The minimum lead to lead spacing should be \geq 0.2mm to minimize shorting.

Lead land length should be equal to the maximum part lead length + 0.3 mm outboard extension. The outboard extension ensures a large and inspectable toe fillet.

The pad lands (the 4 big pads other than the 11 IC pins) length and width should be equal to maximum part pad length and width. However, the minimum metal to metal spacing should be no less than 0.17mm for 2 oz. Copper; no less than 0.1mm for 1 oz. Copper and no less than 0.23mm for 3 oz. Copper.

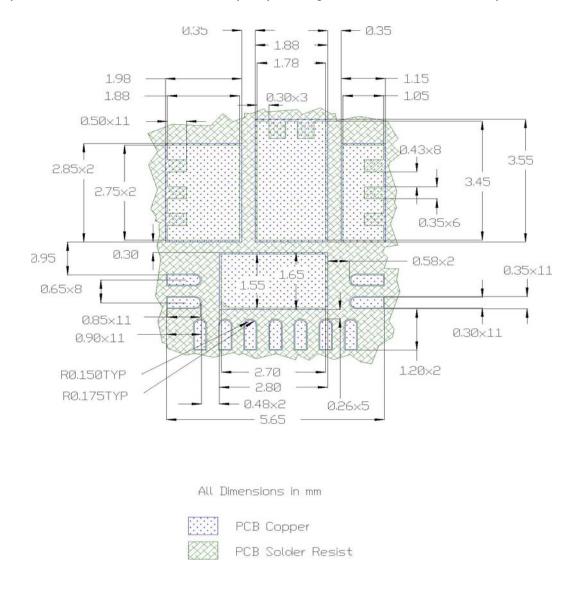


Solder Resist

It is recommended that the lead lands are Non Solder Mask Defined (NSMD). The solder resist should be pulled away from the metal lead lands by a minimum of 0.025mm to ensure NSMD pads.

The land pad should be Solder Mask Defined (SMD), with a minimum overlap of the solder resist onto the copper of 0.05mm to accommodate solder resist mis-alignment.

Ensure that the solder resist in between the lead lands and the pad land is ≥ 0.15 mm due to the high aspect ratio of the solder resist strip separating the lead lands from the pad land.

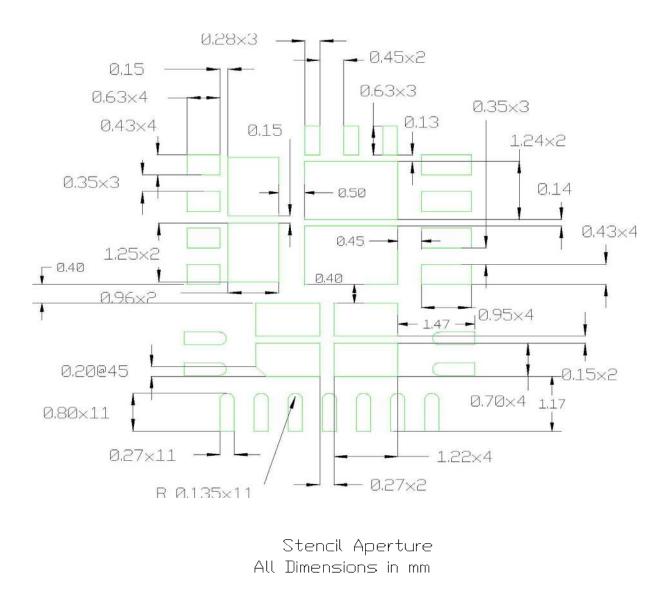


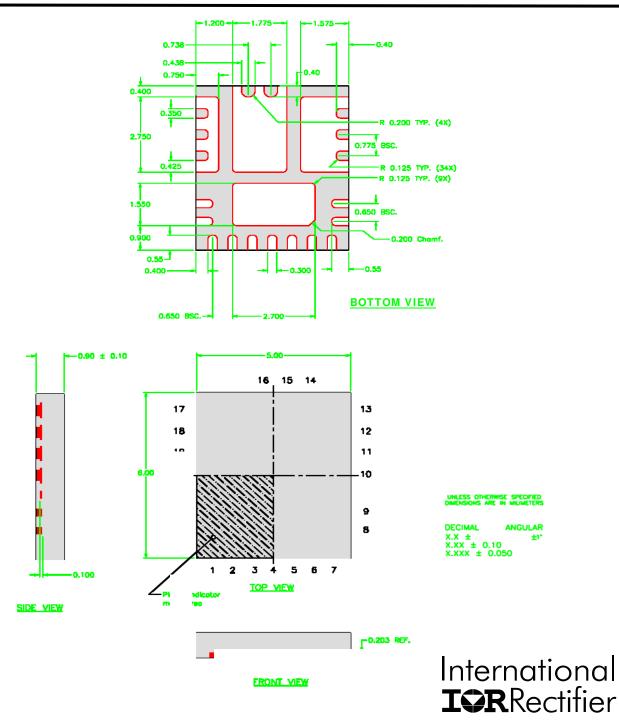




Stencil Design

- The Stencil apertures for the lead lands should be approximately 80% of the area of the lead lads. Reducing the amount of solder deposited will minimize the occurrences of lead shorts. If too much solder is deposited on the center pad the part will float and the lead lands will be open.
- The maximum length and width of the land pad stencil aperture should be equal to the solder resist opening minus an annular 0.2mm pull back to decrease the incidence of shorting the center land to the lead lands when the part is pushed into the solder paste.





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